



MJ N-Channel Enhancement Mode Power MOSFET

Description

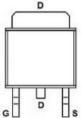
The MJ6080K uses advanced trench technology and design to provide excellent $R_{\text{DS(ON)}}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- ightharpoonup V_{DS} =60V,I_D =80A R_{DS(ON)} <8.5m Ω @ V_{GS}=10V
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- ◆ Excellent package for good heat dissipation

(2) D





Application

Load Switching

▶ PWM

Marking and pin assignment



TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ6080K	MJ6080K	TO-252-2L	2	4	9

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	ID	80	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	56.5	А
Pulsed Drain Current	Ідм	320	А
Maximum Power Dissipation	PD	110	W
Derating factor		0.73	W/°C
Single pulse avalanche energy (Note 5)	Eas	390	mJ
Operating Junction and Storage Temperature Range	Tл,Tsтg	-55 To 175	°C

Thermal Characteristic

Thermal Resistance,Junction-to-Case (Note 2)	Rејс 1.36	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	'	1	ı			
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	60	_	_	V
Zero Gate Voltage Drain Current	loss	Vps=60V,Vgs=0V	-	-	1	μΑ
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	'					
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250μA	2	2.8	4	V
Drain-Source On-State Resistance	Rds(on)	V _{GS} =10V, I _D =20A	-	7	8.5	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	20	_	-	S
Dynamic Characteristics (Note 4)	'	1				
Input Capacitance	Clss		-	4000	-	PF
Output Capacitance	Coss	V _{DS} =30V,V _{GS} =0V F=1.0MHz	-	290	- PF	
Reverse Transfer Capacitance	Crss		-	210	-	PF
Switching Characteristics (Note 4)	'					
Turn-on Delay Time	t _{d(on)}		-	8.5	-	nS
Turn-on Rise Time	tr	V _{DD} =30V, R _L =1Ω	-	7	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =3Ω	-	40	- nS	
Turn-Off Fall Time	tr	- 15		-	nS	
Total Gate Charge	Q _g - 90 -		-	nC		
Gate-Source Charge	Qgs	V _{DS} =30V,I _D =20A V _{GS} =10V	-	9	-	nC
Gate-Drain Charge	V _{GS} =10V		-	nC		
Drain-Source Diode Characteristics	l l					
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	orward Current (Note 2) Is 80		80	А		
Reverse Recovery Time	overy Time		nS			
Reverse Recovery Charge	di/dt=100A/µs (Note 3)		-	nC		
Forward Turn-On Time ton Intrinsic turn-on til		Intrinsic turn-on time is ne	egligible(tu	ırn-on is d	ominated b	uy LS+LD)
Forward Turn-On Time	Intrinsic turn-on time is negligible(turn-on is dominated					уΙ

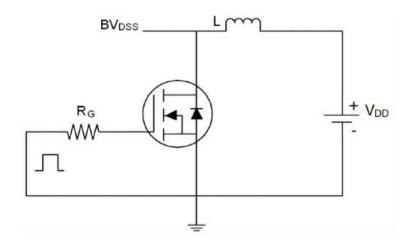
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- \odot EAS condition: Tj=25°C,VDD=20V,VG=10V,L=0.5mH,Rg=25 Ω

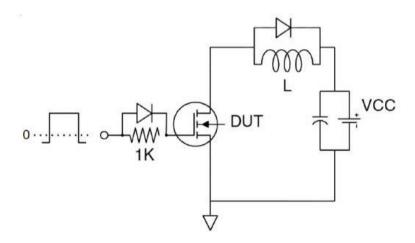




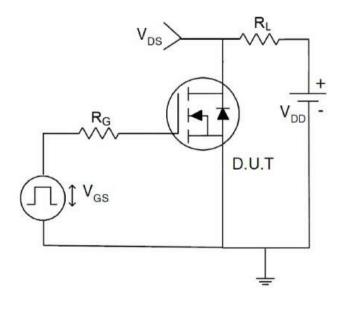
Test circuit



Eas test Circuit



Gate charge test Circuit

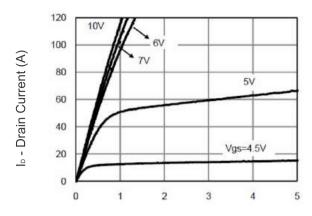


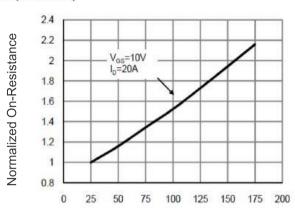
Switch Time Test Circuit



- Drain Current (A)

Typical Electrical and Thermal Characteristics (Curves)



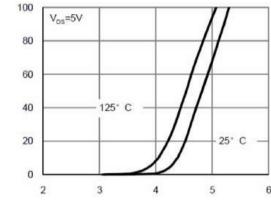


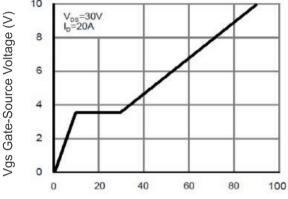
Vds Drain-Source Voltage (V) Figure 1 Output Characteristics

V_{os}=5V

Figure 4 Rdson-Junction Temperature 10

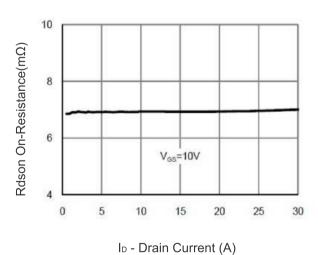
T_J -Junction Temperature(°C)





Vgs Gate-Source Voltage (V) Figure 2 Transfer Characteristics

Qg Gate Charge (nC) Figure 5 Gate Charge



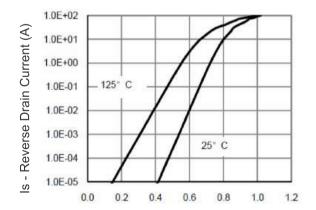
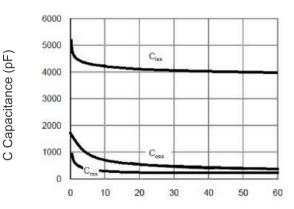


Figure 3 Rdson- Drain Current

Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward



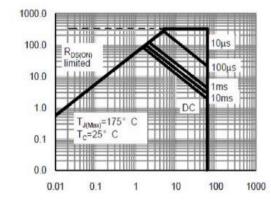
lo - Drain Current (A)

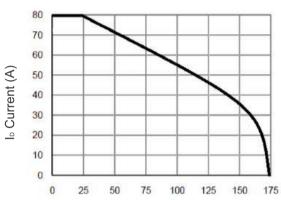


120 100 Power Dissipation (W) 80 60 40 20 0 100 0 25 50 75 125 150

Vds Drain-Source Voltage (V) Figure 7 Capacitance vs Vds

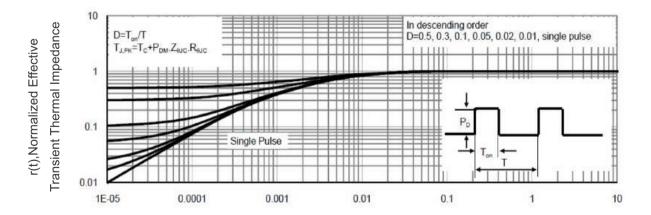
T_J-Junction Temperature (°C) Figure 9 Power De-rating





Vds Drain-Source Voltage (V) Figure 8 Safe Operation Area

T_J-Junction Temperature (°C) Figure 10 lp Current- Junction Temperature



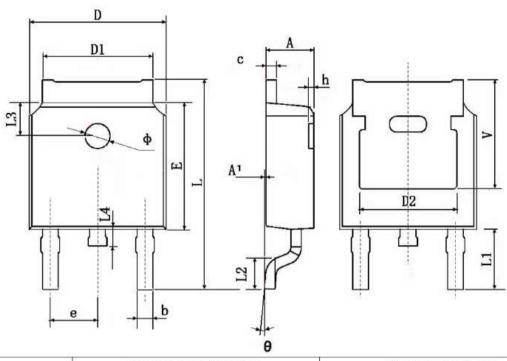
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	0.483 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211	TYP.





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